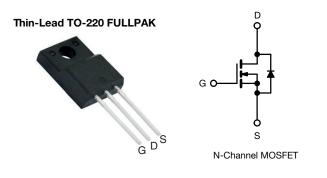
SiHA22N60AE

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.156				
Q _g max. (nC)	96				
Q _{gs} (nC)	12				
Q _{gd} (nC)	25				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free	SiHA22N60AE-E3			
Lead (Pb)-free and halogen-free	SiHA22N60AE-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	V	
Gate-source voltage			V _{GS}	± 30	V	
Continuous drain surrent $(T_{1} - 150 \circ C)^{6}$	V at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$		8		
Continuous drain current ($T_J = 150 \text{ °C}$) ^e	V _{GS} at 10 V	T _C = 100 °C	I _D	5	A	
Pulsed drain current ^a			I _{DM}	49	1	
Linear derating factor				0.26	W/°C	
Single pulse avalanche energy ^b			E _{AS}	204	mJ	
Maximum power dissipation			P _D	33	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °C		d\//d+	70	N//mm	
Reverse diode dV/dt ^d			dV/dt	31	V/ns	
Soldering recommendations (peak temperature) ^c	For 10 s			300	°C	
Mounting torque	M3 screw			0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 3.8 A
- c. 1.6 mm from case
- d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting $T_J = 25 \text{ °C}$

e. Limited by maximum junction temperature

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COMPLIANT

HALOGEN

FREE



SHA

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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum junction-to-ambient	R _{thJA}	-		65		*CAN		
Maximum junction-to-case (drain)	R _{thJC}	- 3.8			- °C/W			
SPECIFICATIONS (T _J = 25 $^{\circ}$ C,	unless otherw	ise noted)						
PARAMETER	SYMBOL	TES	T CONDITIO	NS	MIN.	TYP.	MAX.	UNI
Static								
Drain-source breakdown voltage	V _{DS}	V _{GS} =	: 0 V, I _D = 250) μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D :	= 250 μA	-	0.72	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 25	0 μΑ	2	-	4	V
Gate-source leakage	1		$V_{GS} = \pm 20 V$		-	-	± 100	nA
Gale-Source leakage	I _{GSS}		$V_{GS} = \pm 30 V$		-	-	± 1	μA
Zere gete veltage drein ourrent	I	V _{DS} =	= 600 V, V _{GS} =	= 0 V	-	-	1	μA
Zero gate voltage drain current	IDSS	V _{DS} = 480 \	/, V _{GS} = 0 V, ⁻	Г _Ј = 125 °С	-	-	10	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D =	= 11 A	-	0.156	0.180	Ω
Forward transconductance	9 _{fs}	V _{DS}	= 30 V, I _D = 1	1 A	-	4.8	-	S
Dynamic	•	•			•	•	•	
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1451	-	pF	
Output capacitance	C _{oss}			-	73	-		
Reverse transfer capacitance	C _{rss}			-	5	-		
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	50	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	258	-		
Total gate charge	Qg				-	48	96	1
Gate-source charge	Q _{gs}	V _{GS} = 10 V I _D = 11 A, V _{DS} = 480 V		-	12	-	nC	
Gate-drain charge	Q _{gd}				-	25	-	1
Turn-on delay time	t _{d(on)}				-	19	38	
Rise time	t _r		-		-	33	66	1
Turn-off delay time	t _{d(off)}	$V_{DD} = 480 \text{ V}, \text{ I}_D = 11 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_g = 9.1 \Omega$		-	45	90	- ns	
Fall time	t _f			-	21	42		
Gate input resistance	Rg	f = 1 MHz, open drain		0.3	0.6	1.2	Ω	
Drain-Source Body Diode Characterist								
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	20		
Pulsed diode forward current	I _{SM}			-	-	49	A	
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 11 A, V _{GS} = 0 V		-	-	1.2	V	
Reverse recovery Time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 11 \text{ A},$ dl/dt = 100 A/µs, V _R = 25 V		-	319	638	ns	
Reverse recovery charge	Q _{rr}			-	4.9	9.8	μC	
,	-11			L	28		A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

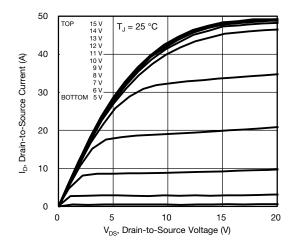


Fig. 1 - Typical Output Characteristics

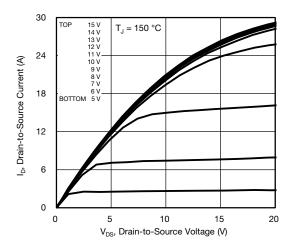


Fig. 2 - Typical Output Characteristics

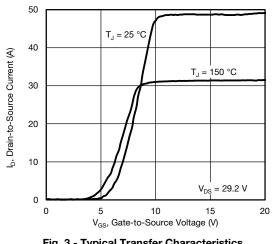


Fig. 3 - Typical Transfer Characteristics

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3.0 = 11 A R_{DS(on)}, Drain-to-Source On-Resistance 2.5 2.0 (Normalized) 1.5 1.0 10 \ GS 0.5 0 -20 -60 -40 20 40 60 80 100 120 140 160 0 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

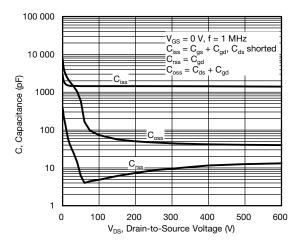


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

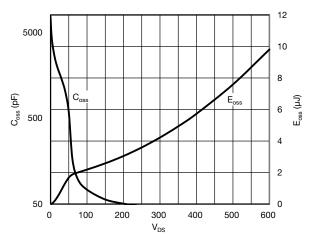


Fig. 6 - Coss and Eoss vs. VDS

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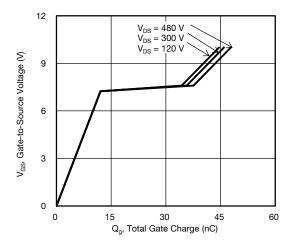


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

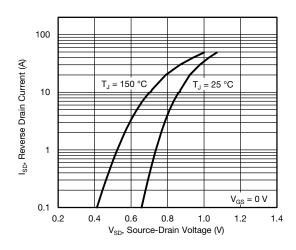


Fig. 8 - Typical Source-Drain Diode Forward Voltage

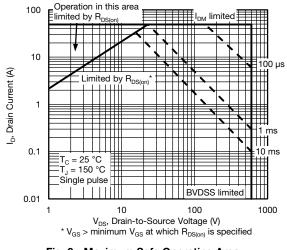


Fig. 9 - Maximum Safe Operating Area

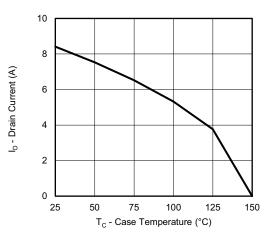


Fig. 10 - Maximum Drain Current vs. Case Temperature

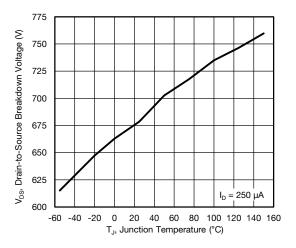
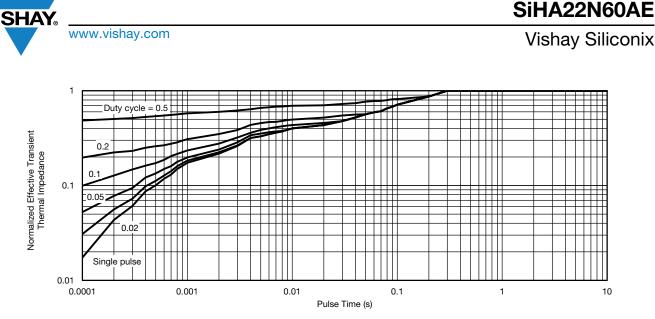


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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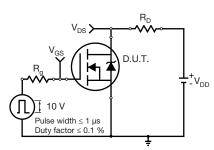


Fig. 13 - Switching Time Test Circuit

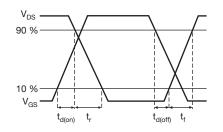


Fig. 14 - Switching Time Waveforms

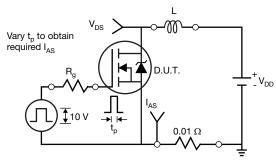


Fig. 15 - Unclamped Inductive Test Circuit

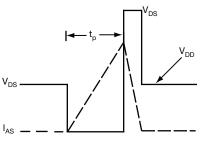


Fig. 16 - Unclamped Inductive Waveforms

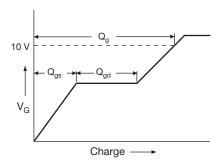


Fig. 17 - Basic Gate Charge Waveform

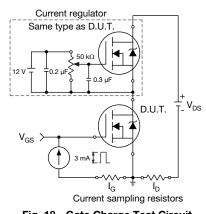
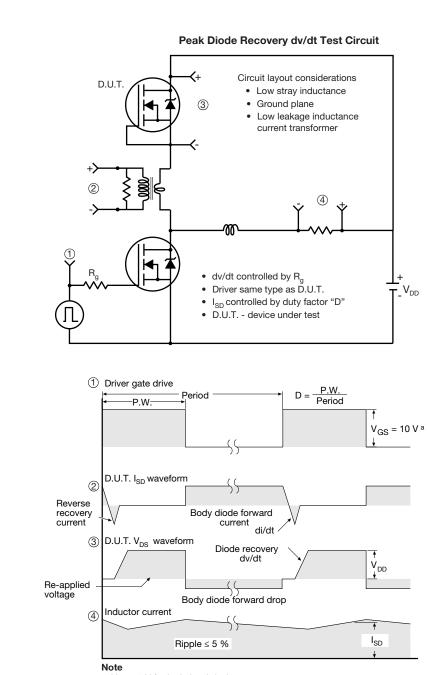


Fig. 18 - Gate Charge Test Circuit

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a. $V_{GS} = 5$ V for logic level devices

Fig. 19 - For N-Channel

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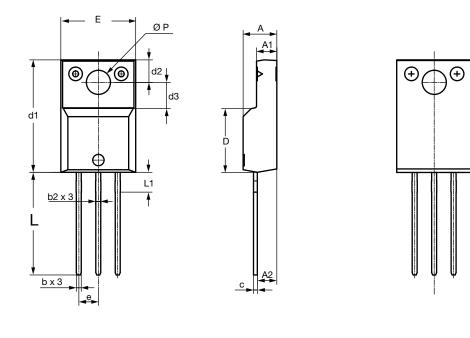
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TO-220 FULLPAK Thin Lead





	DIMENSIONS						
SYMBOL	MILLIN	METERS	INC	HES			
	MIN.	MAX.	MIN.	MAX.			
А	4.30	4.70	0.169	0.185			
A1	2.50	2.90	0.098	0.114			
A2	2.40	2.80	0.094	0.110			
b	0.60	0.80	0.024	0.031			
b2	0.60	0.90	0.024	0.035			
С	-	0.60	-	0.024			
D	8.30	8.70	0.327	0.342			
d1	14.70	15.30	0.579	0.602			
d2	2.90	3.10	0.114	0.122			
d3	3.30	3.70	0.130	0.146			
E	9.70	10.30	0.382	0.406			
е	2.50	2.70	0.098	0.106			
L	13.40	13.80	0.528	0.543			
L1	1.00	2.80	0.039	0.110			
ØP	3.00	3.40	0.118	0.134			
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·				

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